

### BFR380L3

### Linear Low Noise Silicon Bipolar RF Transistor

- High current capability and low noise figure for wide dynamic range
- Collector design supports supply voltage up to 5V
- Ideal for low phase noise oscillators up to 3.5 GHz
- Low noise figure 1.1 dB at 1.8 GHz
- Pb-free (RoHS compliant) and halogen-free thin small leadless package
- Qualification report according to AEC-Q101 available



ESD (Electrostatic discharge) sensitive device, observe handling precaution!

| Туре     | Marking | Pin Configuration |       |       | Package  |  |
|----------|---------|-------------------|-------|-------|----------|--|
| BFR380L3 | FC      | 1 = B             | 2 = E | 3 = C | TSLP-3-1 |  |

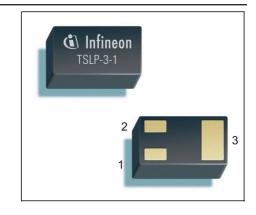
#### **Maximum Ratings** at $T_A$ = 25 °C, unless otherwise specified

| Parameter                             | Symbol           | Value   | Unit |
|---------------------------------------|------------------|---------|------|
| Collector-emitter voltage             | V <sub>CEO</sub> | 6       | V    |
| Collector-emitter voltage             | V <sub>CES</sub> | 15      |      |
| Collector-base voltage                | V <sub>CBO</sub> | 15      |      |
| Emitter-base voltage                  | V <sub>EBO</sub> | 2       |      |
| Collector current                     | I <sub>C</sub>   | 80      | mA   |
| Base current                          | I <sub>B</sub>   | 14      |      |
| Total power dissipation <sup>1)</sup> | P <sub>tot</sub> | 380     | mW   |
| <i>T</i> <sub>S</sub> ≤ 96°C          |                  |         |      |
| Junction temperature                  |                  | 150     | °C   |
| Storage temperature                   | T <sub>Stg</sub> | -55 150 |      |
| Thermal Resistance                    |                  |         | •    |

| Parameter                                | Symbol            | Value | Unit |  |  |
|--|-------------------|-------|------|--|--|
| Junction - soldering point <sup>2)</sup> | R <sub>thJS</sub> | 140   | K/W  |  |  |

 ${}^{1}T_{S}$  is measured on the collector lead at the soldering point to the pcb

<sup>2</sup>For the definition of  $R_{\text{thJS}}$  please refer to Application Note AN077 (Thermal Resistance Calculation)





| Parameter   | Symbol               | Values |      | Unit |    |
|---|----------------------|--------|------|------|----|
|   |                      | min.   | typ. | max. |    |
| DC Characteristics                                      |                      |        |      |      |    |
| Collector-emitter breakdown voltage                     | V <sub>(BR)CEO</sub> | 6      | 9    | -    | V  |
| $I_{\rm C} = 1  {\rm mA},  I_{\rm B} = 0$               |                      |        |      |      |    |
| Collector-emitter cutoff current                        | I <sub>CES</sub>     |        |      |      | nA |
| $V_{\rm CE}$ = 5 V, $V_{\rm BE}$ = 0                    |                      | -      | 1    | 30   |    |
| $V_{\rm CE}$ = 15 V, $V_{\rm BE}$ = 0                   |                      | -      | -    | 1000 |    |
| Collector-base cutoff current                           | I <sub>CBO</sub>     | -      | -    | 30   |    |
| $V_{\rm CB} = 5  \text{V},  I_{\rm E} = 0$              |                      |        |      |      |    |
| Emitter-base cutoff current                             | I <sub>EBO</sub>     | -      | 10   | 500  |    |
| $V_{\rm EB} = 1  \text{V},  I_{\rm C} = 0$              |                      |        |      |      |    |
| DC current gain   | h <sub>FE</sub>      | 90     | 120  | 160  | -  |
| $I_{\rm C}$ = 40 mA, $V_{\rm CE}$ = 3 V, pulse measured |                      |        |      |      |    |

# **Electrical Characteristics** at $T_A$ = 25 °C, unless otherwise specified



| Parameter  | Symbol                          | Values |      | Unit |     |
|--|---------------------------------|--------|------|------|-----|
|  |                                 | min.   | typ. | max. |     |
| AC Characteristics (verified by random sampling  | <u>,</u> )                      | 1      |      |      |     |
| Transition frequency   | f <sub>T</sub>                  | 11     | 14   | -    | GHz |
| $I_{\rm C}$ = 40 mA, $V_{\rm CE}$ = 3 V, $f$ = 1 GHz   |                                 |        |      |      |     |
| Collector-base capacitance   | C <sub>cb</sub>                 | -      | 0.45 | 0.8  | pF  |
| $V_{\rm CB}$ = 5 V, f = 1 MHz, $V_{\rm BE}$ = 0 ,  |                                 |        |      |      |     |
| emitter grounded   |                                 |        |      |      |     |
| Collector emitter capacitance  | C <sub>ce</sub>                 | -      | 0.18 | -    |     |
| $V_{\rm CE}$ = 5 V, f = 1 MHz, $V_{\rm BE}$ = 0 ,  |                                 |        |      |      |     |
| base grounded  |                                 |        |      |      |     |
| Emitter-base capacitance   | C <sub>eb</sub>                 | -      | 1    | -    |     |
| $V_{\rm EB}$ = 0.5 V, f = 1 MHz, $V_{\rm CB}$ = 0 ,  |                                 |        |      |      |     |
| collector grounded   |                                 |        |      |      |     |
| Minimum noise figure   | NF <sub>min</sub>               | 0.5    | 1.1  | 2.1  | dB  |
| $I_{\rm C}$ = 8 mA, $V_{\rm CE}$ = 3 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$ ,                               |                                 |        |      |      |     |
| <i>f</i> = 1.8 GHz   |                                 |        |      |      |     |
| Power gain, maximum available <sup>1)</sup>  | G <sub>ma</sub>                 |        |      |      |     |
| $I_{\rm C}$ = 40 mA, $V_{\rm CE}$ = 3 V, $Z_{\rm S}$ = $Z_{\rm Sopt,}$ $Z_{\rm L}$ = $Z_{\rm Lopt,}$ |                                 |        |      |      |     |
| <i>f</i> = 1.8 GHz   |                                 | 11.5   | 14   | 16.5 |     |
| <i>f</i> = 3 GHz   |                                 | 7.5    | 10   | 12.5 |     |
| Transducer gain  | S <sub>21e</sub>   <sup>2</sup> |        |      |      | dB  |
| $I_{\rm C}$ = 40 mA, $V_{\rm CE}$ = 3 V, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 $\Omega$ ,                   |                                 |        |      |      |     |
| <i>f</i> = 1.8 GHz   |                                 | 9.5    | 11.5 | 13.5 |     |
| <i>f</i> = 3 GHz   |                                 | 5.5    | 7.5  | 9.5  |     |
| Third order intercept point at output <sup>2)</sup>  | IP3                             | -      | 29.5 | -    | dBm |
| V <sub>CE</sub> = 3 V, <i>I</i> <sub>C</sub> = 40 mA, <i>f</i> = 1.8 GHz,                            |                                 |        |      |      |     |
| $Z_{\rm S} = Z_{\rm L} = 50\Omega$   |                                 |        |      |      |     |
| 1dB compression point at output  | P <sub>-1dB</sub>               |        |      |      |     |
| <i>I</i> <sub>C</sub> = 40 mA, <i>V</i> <sub>CE</sub> = 3V, <i>f</i> = 1.8 GHz                       |                                 |        |      |      |     |
| $Z_{\rm S} = Z_{\rm L} = 50\Omega$   |                                 | -      | 16   | -    |     |
| $Z_{\rm S} = Z_{\rm Sopt,} \ Z_{\rm L} = Z_{\rm Lopt}$   |                                 | -      | 19.5 | -    |     |

### **Electrical Characteristics** at $T_A = 25$ °C, unless otherwise specified

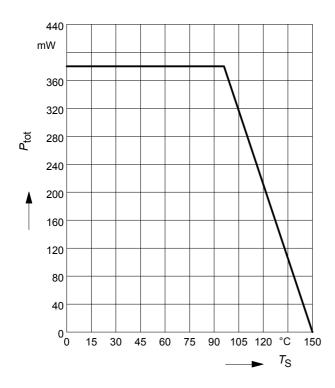
 ${}^{1}G_{\rm ma} = |S_{21e} / S_{12e}| \ (k - (k^2 - 1)^{1/2})$ 

<sup>2</sup>IP3 value depends on termination of all intermodulation frequency components. Termination used for this measurement is 500 from 0.1 MHz to 6 CHz

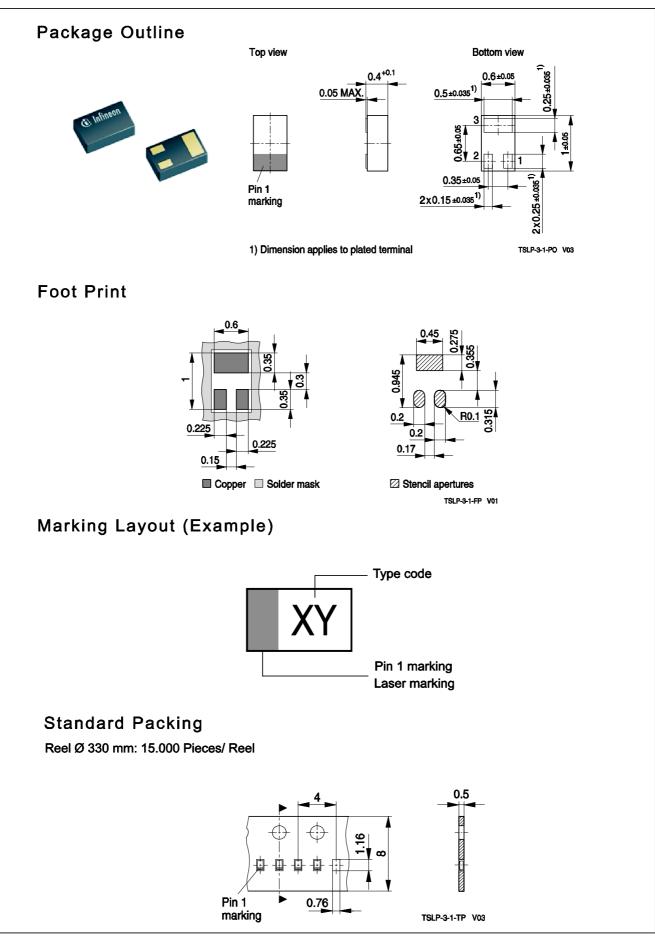
Termination used for this measurement is 50  $\Omega$  from 0.1 MHz to 6 GHz



## Total power dissipation $P_{tot} = f(T_S)$









Edition 2009-11-16

Published by Infineon Technologies AG 81726 Munich, Germany

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